

## C1206J223K1RACTU

Aliases (C1206J223K1RAC7800) SMD Comm X7R FO, Ceramic, 0.022 uF, 10%, 100 VDC, X7R, SMD, MLCC, Open Mode, Temperature Stable, 1206, 1.5 mm



General Information	
Series	SMD Comm X7R FO
Style	SMD Chip
Description	SMD, MLCC, Open Mode, Temperature Stable
Features	Open Mode, Temperature Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	25 mg
Shelf Life	78 Weeks
MSL	1

0.022 uF

3% Loss/Decade Hour: Referee

Time is 1000 Hours

45.4545 GOhms

Dimensions	
Chip Size	1206
L	3.3mm +/-0.4mm
W	1.6mm +/-0.35mm
Т	0.9mm +/-0.20mm
S	1.5mm MIN
В	0.6mm +/-0.25mm

3.3mm +/-0.4mm	Measurement Condition	1 kHz 1.0Vrms
1.6mm +/-0.35mm	Tolerance	10%
0.9mm +/-0.20mm	Voltage DC	100 VDC
1.5mm MIN	Dielectric Withstanding Voltage	250 VDC
0.6mm +/-0.25mm	Temperature Range	-55/+125°C
	Temp. Coefficient	X7R
	Capacitance Change with	15%, 1kHz 1.0Vrms
T&R, 180mm, Plastic Tape	Reference to +25°C and 0 VDC Applied (TCC)	
4000	Dissipation Factor	2.5% 1 kHz 1.0 Vrms

Specifications
Capacitance

Aging Rate

Insulation Resistance

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	4000

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

Generated 05/04/2025 © 2006 - 2025 YAGEO